

Announcement

INTERNATIONAL SOCIETY FOR HYBRID MICROELECTRONICS

The International Society for Hybrid Microelectronics is based in the U.S.A., and there are independent parallel organisations throughout the world. These groups are independent, non-profit-making organisations, the purpose of which is to provide an informal means of discussing and advancing hybrid technology. This is achieved by the organisation of meetings, the publication of a Newsletter and other activities as appropriate. Membership is open to all and there are no formal entry requirements.

All these societies run a programme of meetings throughout the year on subjects concerned with thick films, and interested readers are advised to contact the following Chairmen for details of meetings in their own areas:

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- In addition, the European Chapters are all linked together through the European Liaison Committee.
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